***Customer:**

SPECIFICATION

ITEM	FLASH LED DEVICE
MODEL	FCW200Z
REVISION DATE	Rev0.5(070727)

[Contents]

Drawn by	Checked by	Approved by

SEOUL SEMICONDUCTOR CO,. LTD.
148-29 Kasan-Dong, Keumchun-Gu, Seoul, Korea
TEL: 82-2-3281-6269 FAX: 82-2-858-5537

1. Features

- □ Package : 2.3 × 1.9 × 0.75 mm
- □ Color coordinates: according to CIE 1931
- □ Tape and reel packing

2. Absolute Maximum Ratings

(Ta=25℃)

Parameter	Symbol	Value	Unit
Power Dissipation	P_d	800	mW
Forward Current	I_F	250	mA
Peak Forward Current	I_{FM} *1	750	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-30 ~ 80	℃
Storage Temperature	T_{stg}	-40 ~ 100	℃

*1 I_{FM} conditions: Pulse width Tw≤ 300ms, Duty ratio≤ 1/10

3. Electro-Optical Characteristics

(Ta=25℃)

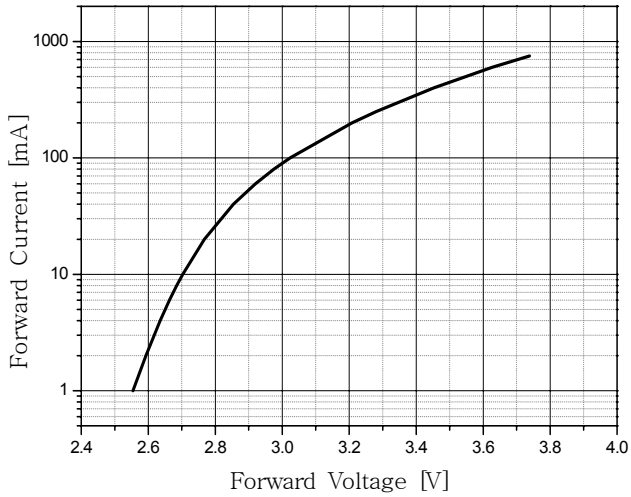
Characteristics	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	V_F	I_F=250mA	-	3.2	-	V
Reverse Current	I_R	V_R=5V	-	-	50	μA
Luminous Intensity *2	I_V	I_F=250mA	-	14	-	cd
		I_F=400mA (Flash mode) *3	-	20	-	
		I_F=750mA (Peak current mode) *4	-	30	-	
Illumination	lx	I_F=400mA (Flash mode) *3		41		lx@0.7m
				20		lx@1m
Luminous Flux	lm	I_F=250mA		39.5		lm
Chromaticity Coordinates	X	I_F=250mA	-	0.31	-	
	Y	I_F=250mA	-	0.32	-	
Viewing Angle	$\Delta 1/2\theta$	I_F=250mA	-	115	-	°

*2 The luminous intensity I_V is measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.
*3 Flash mode condition is Pulse width Tw = 2sec, Duty ratio = 2 / 7
*4 Peak current mode is Pulse width Tw≤ 300ms, Duty ratio≤ 1/10

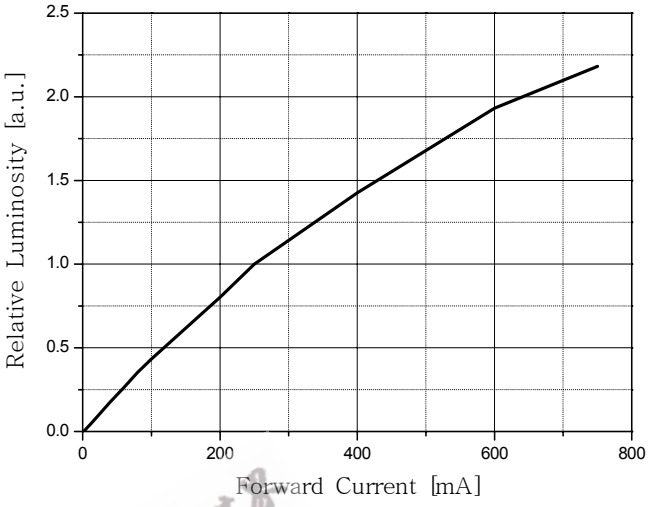
[Note] (Tolerance : IV 10%, color coordinate 0.01, VF 0.1)

SEOUL SEMICONDUCTOR CO,. LTD.
148-29 Kasan-Dong, Keumchun-Gu, Seoul, Korea
TEL: 82-2-3281-6269 FAX: 82-2-858-5537

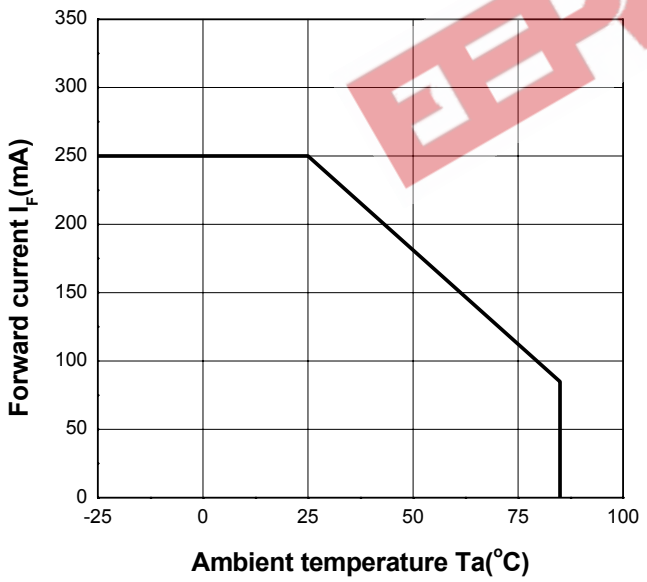
Forward Current vs. Forward Voltage



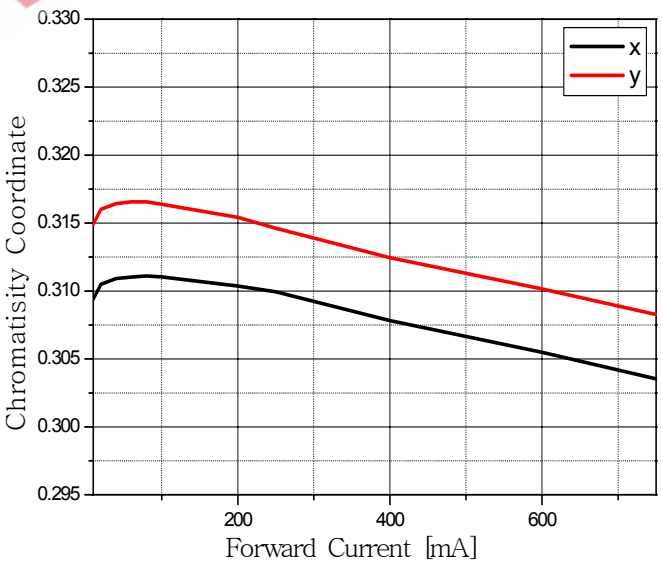
Luminous Intensity vs. Forward Current



Forward Current Derate Curve

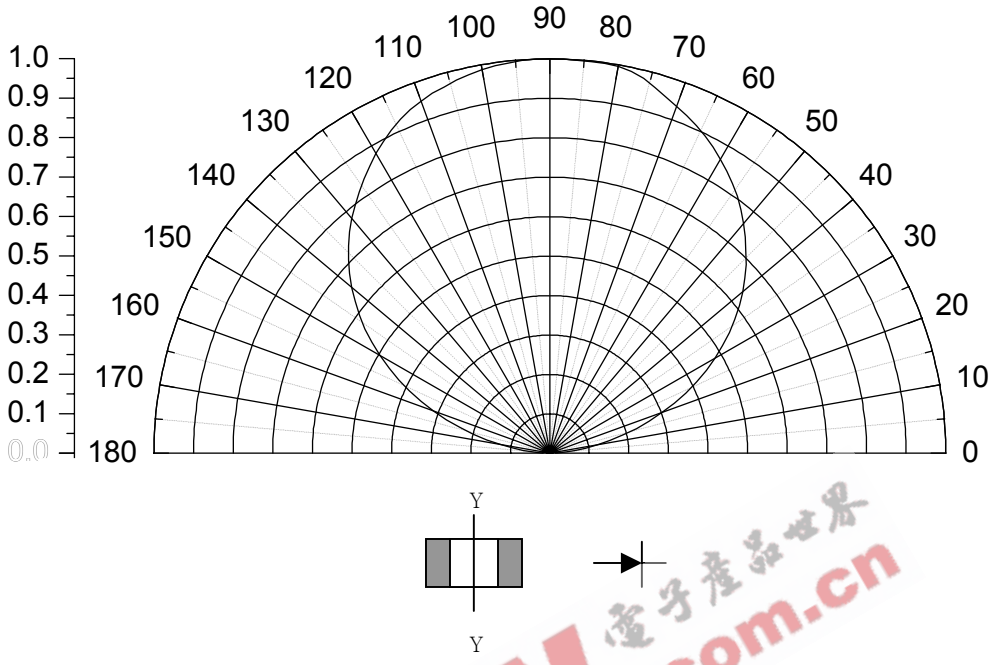


Forward Current vs Chromaticity Coordinate

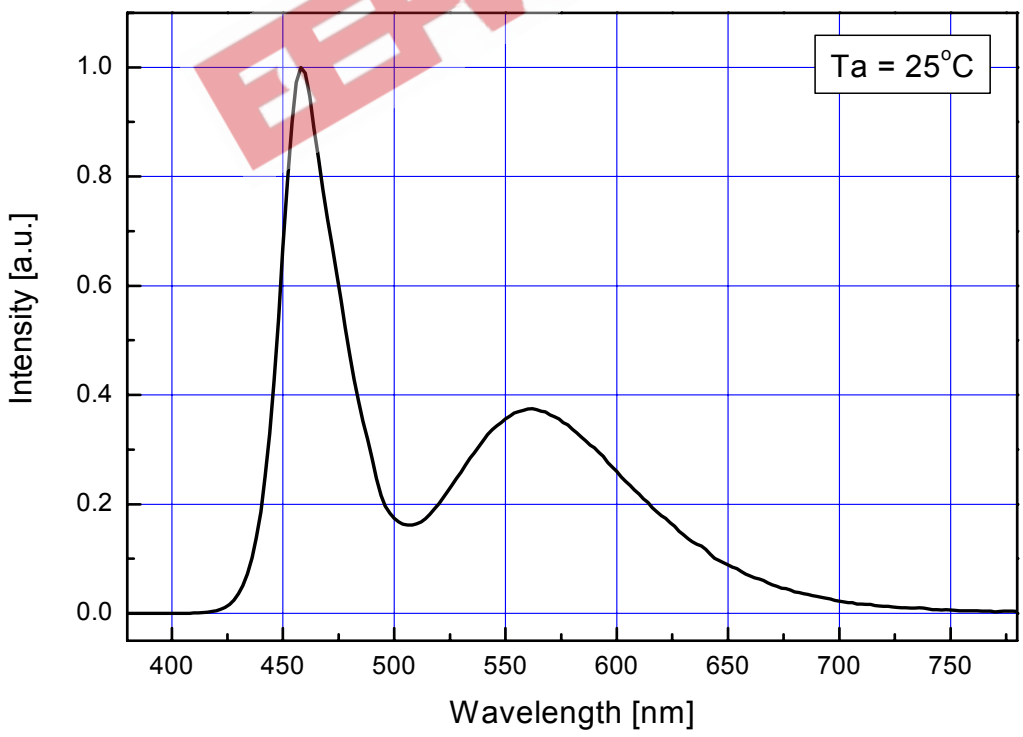


(Ta=25℃)

Radiation Diagram



Spectrum



SEOUL SEMICONDUCTOR CO,. LTD.
148-29 Kasan-Dong, Keumchun-Gu, Seoul, Korea
TEL: 82-2-3281-6269 FAX: 82-2-858-5537

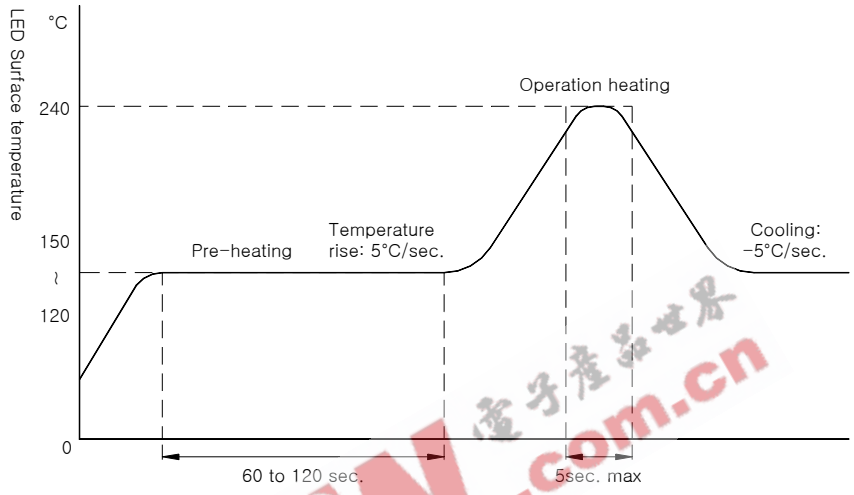
4. Soldering Profile

Reflow Soldering Conditions/ Profile

(1) Lead Solder

-Preliminary heating to be at 150℃max. for 2 minutes max.

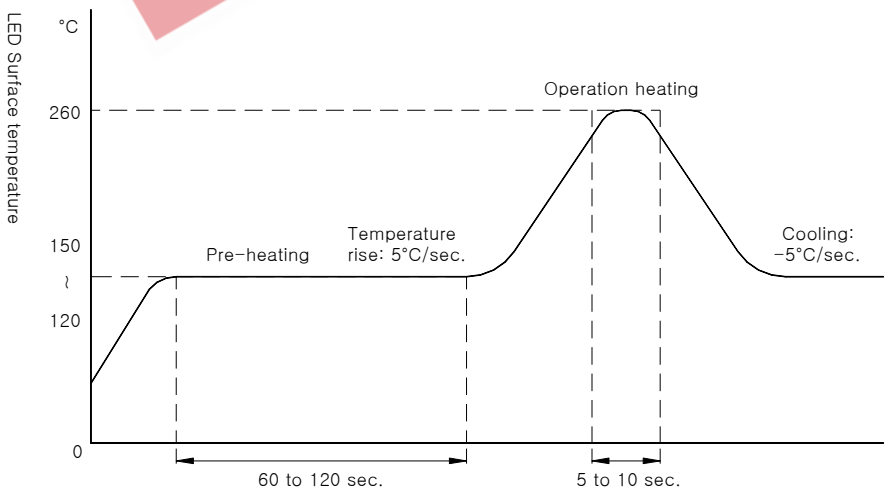
-Soldering heat to be at 240℃max. for 5 seconds max.



(2) Lead-Free Solder

-Preliminary heating to be at 150℃max. for 2 minutes max.

-Soldering heat to be at 260℃max. for 10 seconds max.



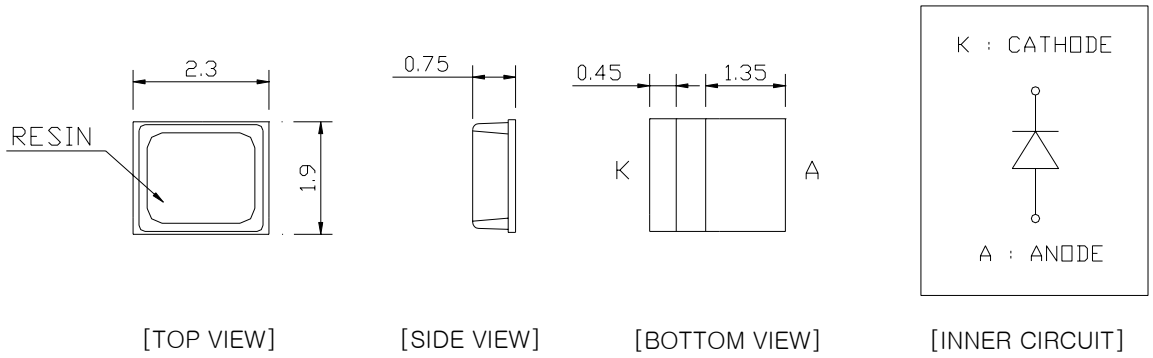
(3) Hand Soldering conditions

-Not more than 3 seconds @MAX280℃, under Soldering iron.

SEOUL SEMICONDUCTOR CO,. LTD.
148-29 Kasan-Dong, Keumchun-Gu, Seoul, Korea
TEL: 82-2-3281-6269 FAX: 82-2-858-5537

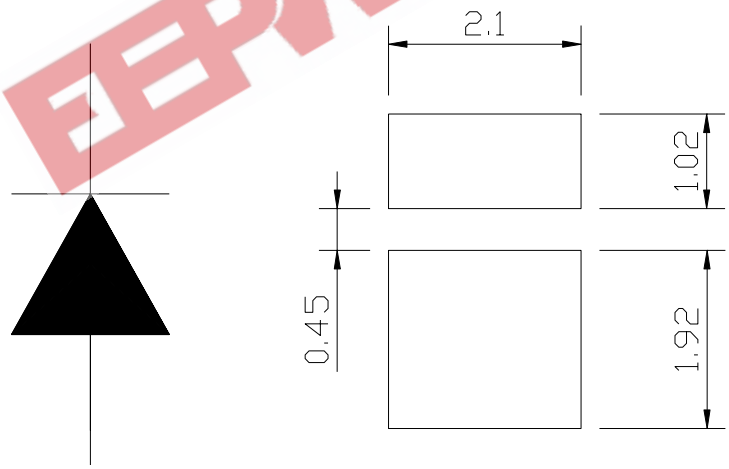
5. Outline Dimension

Tolerance: ±0.1, Unit: ㎜



[TOP VIEW] [SIDE VIEW] [BOTTOM VIEW] [INNER CIRCUIT]

* Recommend solder pad pattern



- Please refer to the *"Thermal Design Guideline for Hi Power Flash LED"* for heat dissipation pattern design.

SEOUL SEMICONDUCTOR CO,. LTD.
148-29 Kasan-Dong, Keumchun-Gu, Seoul, Korea
TEL: 82-2-3281-6269 FAX: 82-2-858-5537

6. Precaution for use

(1) Storage

In order to avoid the absorption of moisture, it is recommended to store in the dry box (or desicator) with a desiccant . Otherwise, to store them in the following environment is recommended.

Temperature : 5℃~30℃ Humidity : 60%HR max.

(2) Attention after opened

However LED is corresponded SMD, when LED be soldered dip, interfacial separation may affect the light transmission efficiency, causing the light intensity to drop. Attention in followed.

a. After opened and mounted, the soldering shall be quickly. b. Keeping of a fraction

Temperature : 5 ~ 40℃ Humidity : less than 30%

(3) In case of more than 1 week passed after opening or change color of indicator on desiccant components shall be dried 10-12hr. at 60±5℃.

(4) In case of supposed the components is humid, shall be dried dip-solder just before.

100Hr at 80±5℃ or 12Hr at 100±5℃.

(5) Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temp. after soldering.

(6) Quick cooling shall not be avoid.

(7) Components shall not be mounted on warped direction of PCB.

(8) Anti radioactive ray design is not considered for the products listed here in.

(9) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA should be used.

(10) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.

(11) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.

(12) The LEDs must be soldered within seven days after opening the moisture-proof packing.

(13) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.

(14) The appearance and specifications of the product may be modified for improvement without notice.

(15) Static Electricity and surge damages the Blue LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be properly grounded.

(16) It is recommended to use individual resistor separately when the LEDs applies in parallel circuit so that it may improve the light deviations.

SEOUL SEMICONDUCTOR CO,. LTD.
148-29 Kasan-Dong, Keumchun-Gu, Seoul, Korea
TEL: 82-2-3281-6269 FAX: 82-2-858-5537